SiZ322DT

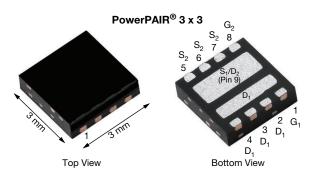
RoHS

COMPLIANT

www.vishay.com

Vishay Siliconix

Dual N-Channel 25 V (D-S) MOSFET



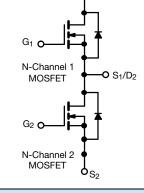
| PRODUCT SUMMARY | | | | | |
|--|---------|--|--|--|--|
| MOSFET CHANNEL-1 AND CHANNEL-2 | | | | | |
| V _{DS} (V) | 25 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V | 0.00635 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V | 0.00900 | | | | |
| Q _g typ. (nC) | 6.2 | | | | |
| I _D (A) ^{a, d} | 30 | | | | |
| Configuration | Dual | | | | |

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- High side and low side MOSFETs form optimized combination for 50 % duty cycle
- Optimized R_{DS} Q_g and R_{DS} Q_{gd} FOM elevates efficiency for high frequency switching
- 100 % R_{α} and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous buck
- DC/DC conversion
- Half bridge
- POL



ORDERING INFORMATION

| Package | PowerPAIR 3 x 3 |
|---------------------------------|-----------------|
| Lead (Pb)-free and halogen-free | SiZ322DT-T1-GE3 |

| DADAMETER | | CHANNEL-1 AND CHANNEL-2 | | | |
|---|------------------------|-----------------------------------|----------------------|-----|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Drain-source voltage | V _{DS} | 25 | V | | |
| Gate-source voltage | | V _{GS} | +16 / -12 | | |
| | T _C = 25 °C | | 30 ^a | | |
| Continuous drain current (T _J = 150 °C) | T _C = 70 °C | | 30 ^a | | |
| | T _A = 25 °C | I _D | 19 ^{b, c} | | |
| | T _A = 70 °C | | 15.2 ^{b, c} | | |
| Pulsed drain current (t = 100 μs) | | I _{DM} | 100 | — A | |
| | T _C = 25 °C | | 13.9 | | |
| Continuous source current (MOSFET diode conduction) | T _A = 25 °C | I _S | 3.1 ^{b, c} | | |
| Single pulse avalanche current | | I _{AS} | 15 | | |
| L = 0.1 mH | | E _{AS} | 11.25 | mJ | |
| | T _C = 25 °C | | 16.7 | | |
| Maximum power dissipation | T _C = 70 °C | | 10.7 | | |
| | T _A = 25 °C | P _D | 3.7 ^{b, c} | W | |
| | T _A = 70 °C | | 2.4 ^{b, c} | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | | |
| Soldering recommendations (peak temperature) | | Ŭ | 260 | | |

Notes a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. $T_C = 25 \ ^\circ C$

S17-0248-Rev. A, 20-Feb-17

1

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THERMAL RESISTANCE RATINGS

| PABAMETER | | | CHANNEL-1 AND CHANNEL-2 | | |
|----------------------------------|--------------|-------------------|-------------------------|---------|------|
| FARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT |
| Maximum junction-to-ambient a, b | t ≤ 10 s | R _{thJA} | 27 | 34 | °C/W |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 6 | 7.5 | 0/11 |

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 69 °C/W

| SPECIFICATIONS ($T_J = 25 \circ C$ | , unless othe | erwise noted) | | | | |
|---|---------------------|--|---------|---------|---------|---|
| | | CHANNEL-1 AND | CHANNEL | -2 | | |
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Static | | · | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 25 | - | - | V |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1 | - | 2.4 | v |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = +16 V / -12 V$ | - | - | ± 100 | nA |
| Zava gata valtaga drain avreat | | $V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | - | - | 1 | |
| Zero gate voltage drain current | IDSS | $V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$ | - | - | 5 | μΑ |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 40 | - | - | А |
| Durin counce on state mariatements | P | V _{GS} = 10 V, I _D = 15 A | - | 0.00529 | 0.00635 | $\begin{array}{c c} - & \\ 2.4 & \\ \pm 100 & nA \\ 1 & \\ \pm 100 & nA \\ \hline 1 & \\ - & A \\ 0.00635 & \\ 0.00900 & \\ - & S \\ \hline 0.00900 & \\ - & S \\ \hline 0.00900 & \\ - & S \\ \hline 0.00900 & \\ -$ |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | - | 0.00750 | 0.00900 | <u>(</u> 2 |
| Forward transconductance a | g _{fs} | V _{DS} = 10 V, I _D = 15 A | - | 57 | - | S |
| Dynamic ^b | | · | | | | |
| Input capacitance | C _{iss} | | - | 950 | - | |
| Output capacitance | C _{oss} | | - | 275 | - | pF |
| Reverse transfer capacitance | C _{rss} | V _{DS} = 12.5 V, V _{GS} = 0 V, f = 1 MHz | - | 50 | - | |
| C _{rss} /C _{iss} ratio | | | - | 0.053 | 0.106 | |
| Total gata abayaa | 0 | $V_{DS} = 12.5 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 19 \text{ A}$ | - | 13.4 | 20.1 | |
| Total gate charge | Qg | | - | 6.2 | 9.3 | |
| Gate-source charge | Q _{gs} | V_{DS} = 12.5 V, V_{GS} = 4.5 V, I_{D} = 19 A | - | 2.7 | - | no |
| Gate-drain charge | Q _{gd} | | - | 1.1 | - | |
| Gate resistance | R _g | f = 1 MHz | 0.2 | 0.8 | 1.6 | Ω |
| Turn-on delay time | t _{d(on)} | | - | 10 | 20 | |
| Rise time | t _r | V_{DD} = 12.5 V, R _L = 0.8 Ω, I _D ≅ 15.2 A, | - | 25 | 50 | |
| Turn-off delay time | t _{d(off)} | $V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$ | - | 15 | 30 | |
| Fall time | t _f |] [| - | 15 | 30 | 20 |
| Turn-on delay time | t _{d(on)} | | - | 15 | 30 | 115 |
| Rise time | t _r | $V_{DD} = 12.5 \text{ V}, \text{ R}_{L} = 0.8 \Omega, \text{ I}_{D} \cong 15.2 \text{ A},$ | - | 45 | 70 | |
| Turn-off delay time | t _{d(off)} | $V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$ | - | 20 | 40 | |
| Fall time | t _f |] [| - | 25 | 50 | |



SiZ322DT

Vishay Siliconix

SPECIFICATIONS ($T_J = 25 \text{ °C}$, unless otherwise noted)

| SPECIFICATIONS $(1) = 25$ C, U | | , | | | | | |
|---------------------------------------|-------------------------|--|------|------|------|------|--|
| PARAMETER | CHANNEL-1 AND CHANNEL-2 | | | | | | |
| FANAMETEN | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
| Drain-source Body Diode Characteristi | cs | | | | | | |
| Continuous source-drain diode current | I _S | $T_{\rm C} = 25^{\circ}{\rm C}$ | - | - | 30 | А | |
| Pulse diode forward current | I _{SM} | | | - | 100 | | |
| Body diode voltage | V _{SD} | $I_{S} = 15.2 \text{ A}, V_{GS} = 0 \text{ V}$ | - | 0.85 | 1.2 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 32 | 44 | ns | |
| Body diode reverse recovery charge | Q _{rr} | I _F = 15.2 A, dl/dt = 100 A/μs, | - | 22 | 44 | nC | |
| Reverse recovery fall time | ta | T _J = 25 °C | - | 15 | - | 20 | |
| Reverse recovery rise time | t _b | | - | 17 | - | ns | |

Notes

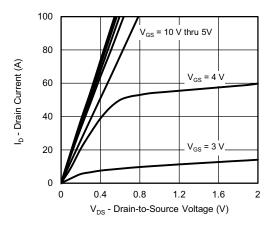
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

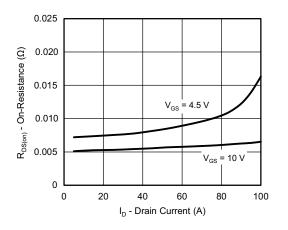
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



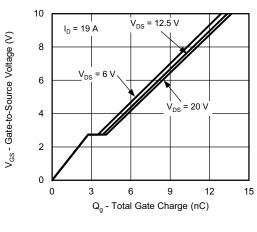
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



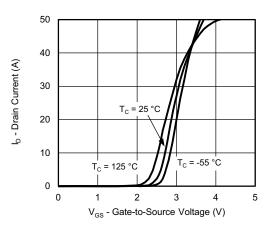
Output Characteristics



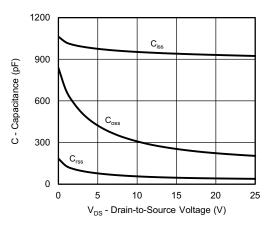
On-Resistance vs. Drain Current and Gate



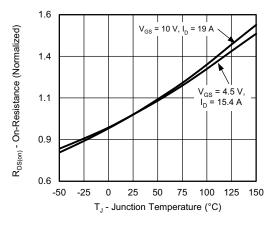
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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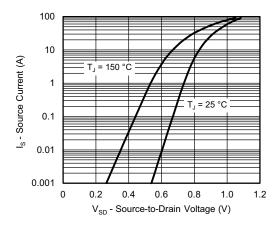
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Document Number: 79370

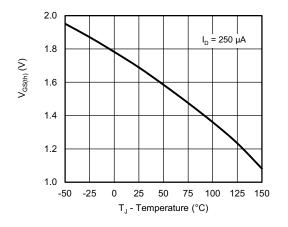
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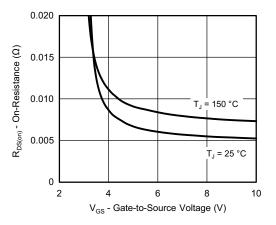
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



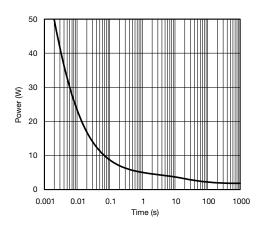
Source-Drain Diode Forward Voltage



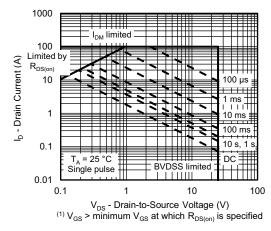
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



Safe Operating Area, Junction-to-Ambient

S17-0248-Rev. A, 20-Feb-17

5

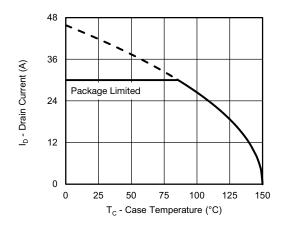
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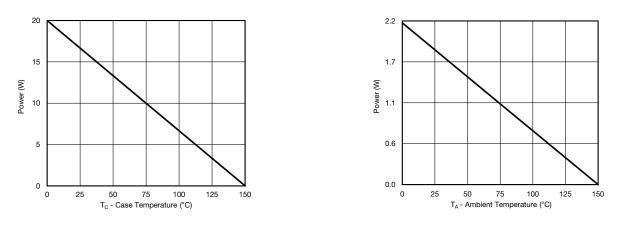
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

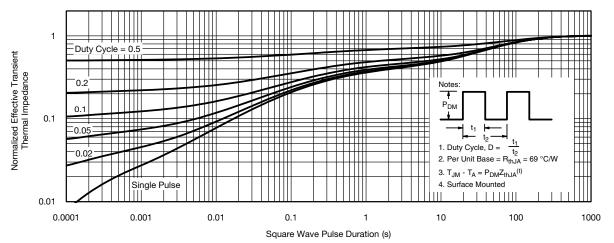
Power, Junction-to-Ambient

Note

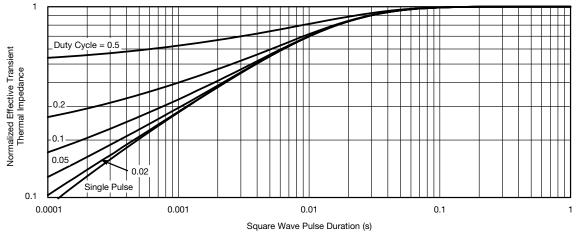
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

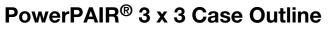


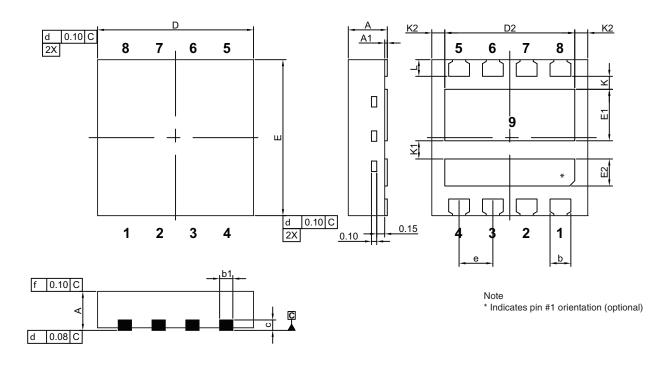
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?79370.

7







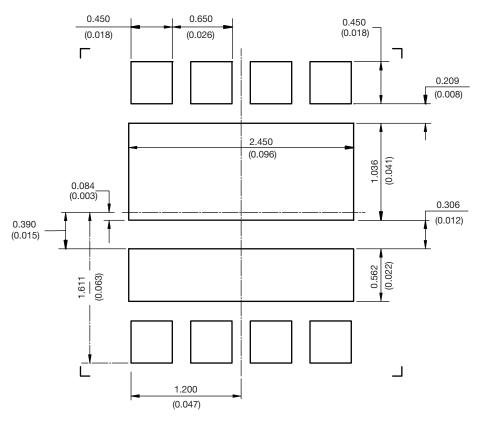
| | | MILLIMETERS | | INCHES | | | |
|------|-----------|-------------|------|--------|------------|-------|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | |
| А | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 | |
| b1 | 0.20 | 0.25 | 0.38 | 0.008 | 0.010 | 0.015 | |
| С | 0.18 | 0.20 | 0.23 | 0.007 | 0.008 | 0.009 | |
| D | 2.90 | 3.00 | 3.10 | 0.114 | 0.118 | 0.122 | |
| D2 | 2.35 | 2.40 | 2.45 | 0.093 | 0.094 | 0.096 | |
| E | 2.90 | 3.00 | 3.10 | 0.114 | 0.118 | 0.122 | |
| E1 | 0.94 | 0.99 | 1.04 | 0.037 | 0.039 | 0.041 | |
| E2 | 0.47 | 0.52 | 0.57 | 0.019 | 0.020 | 0.022 | |
| е | | 0.65 BSC | | | 0.026 BSC | | |
| К | | 0.25 typ. | | | 0.010 typ. | | |
| K1 | | 0.35 typ. | | | 0.014 typ. | | |
| K2 | 0.30 typ. | | | | 0.012 typ. | | |
| L | 0.27 | 0.32 | 0.37 | 0.011 | 0.013 | 0.015 | |



PAD Pattern

Vishay Siliconix

RECOMMENDED MINIMUM PAD FOR PowerPAIR® 3 x 3



Recommended PAD for PowerPAIR 3 x 3 Dimensions in millimeters (inches) Keep-Out 3.5 mm x 3.5 mm for non terminating traces



Vishay

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